

PRODUCT SPECIFICATION

Product Name	ST50H LoRa Wireless Communication Module
Version	D
Doc No	901-12601
Date	2021/05/21



Document History

Date	Revised Contents	Revised By	Version
2020/03/26	Initial release	PW	A
2020/05/08	Update Pin Definition	PW	B
2020/11/03	Modify TX/RX Spec.	Jack	C
2021/05/21	Modify Tx Power Spec.	Jack	D



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